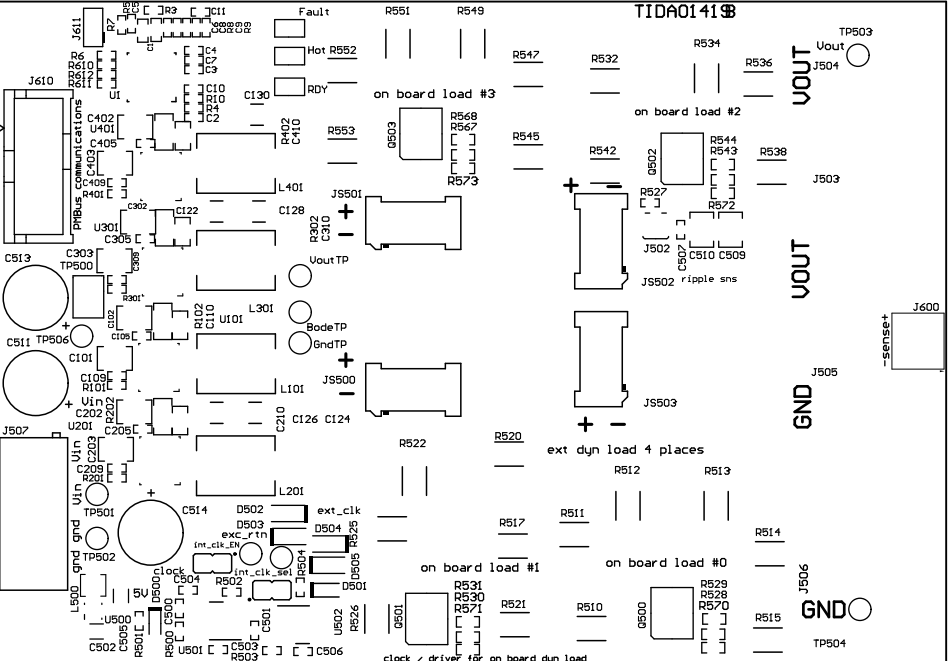
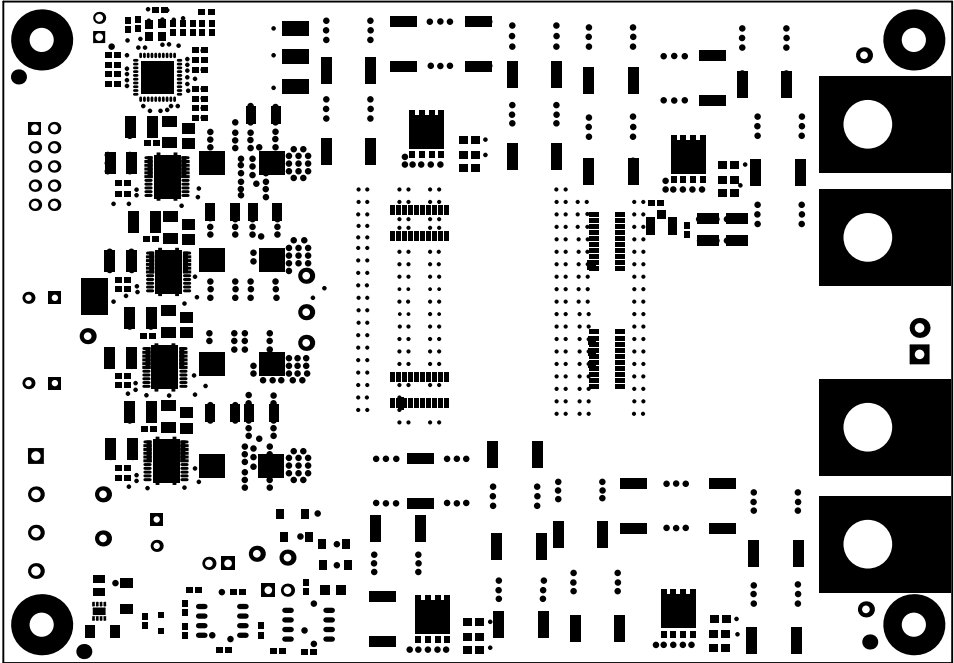
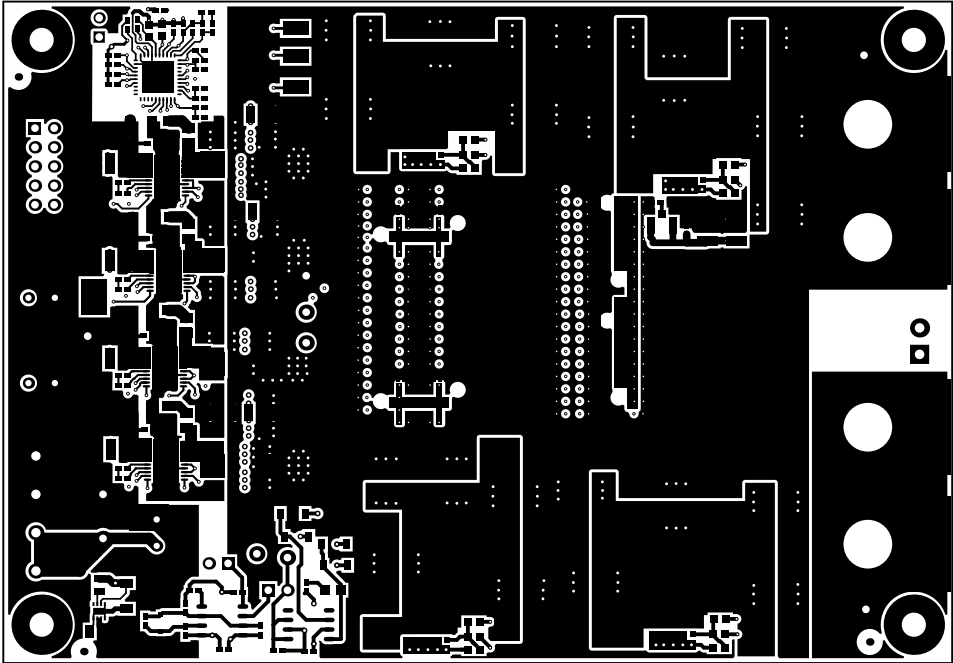




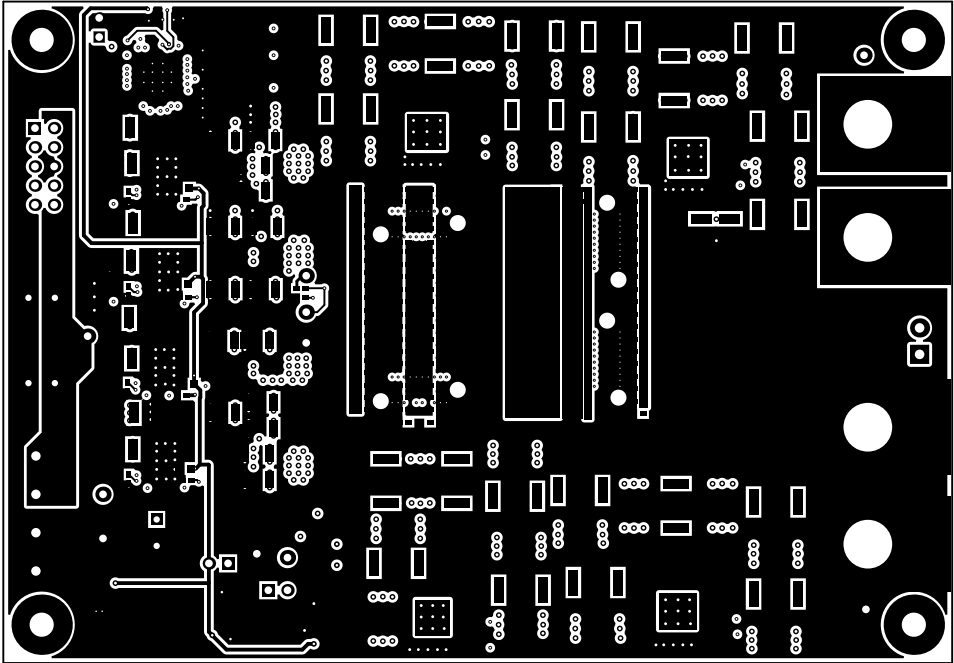
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01419	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA01419		
PLOT NAME = Top Overlay	GENERATED : 4/13/2017 2:03:04 PM		TEXAS INSTRUMENTS



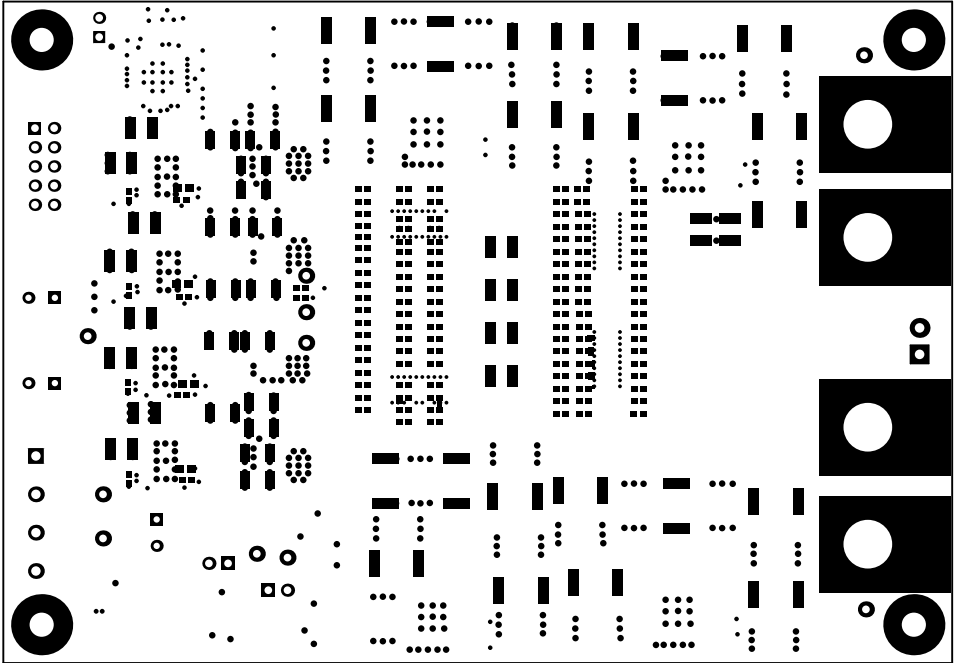
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01419	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA01419		
PLOT NAME = Top Solder Mask	GENERATED : 4/13/2017 2:03:06 PM	TEXAS INSTRUMENTS	



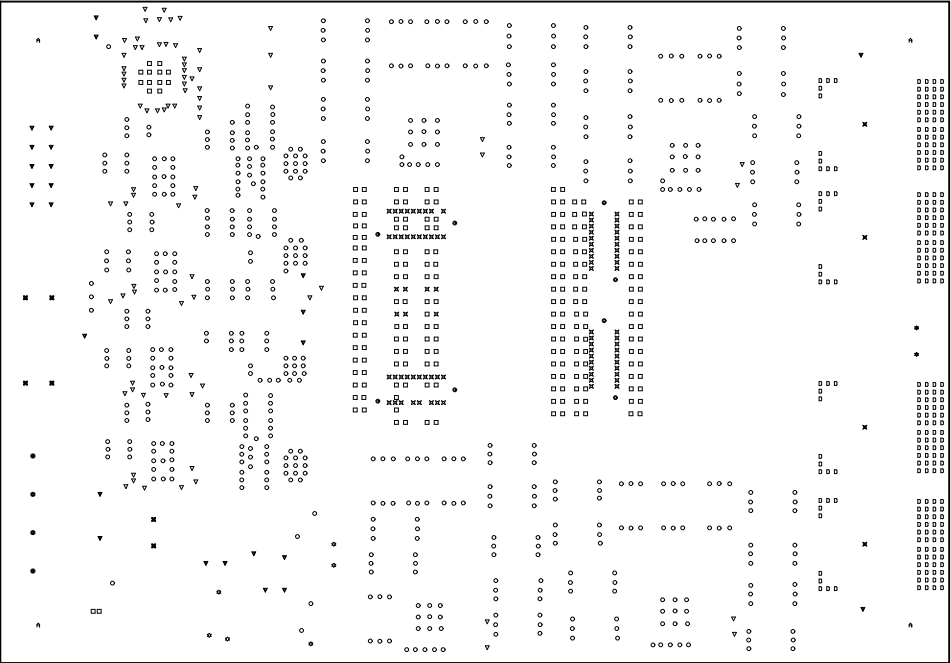
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01419	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA01419		
PLOT NAME = Top Layer	GENERATED : 4/13/2017 2:03:08 PM	TEXAS INSTRUMENTS	



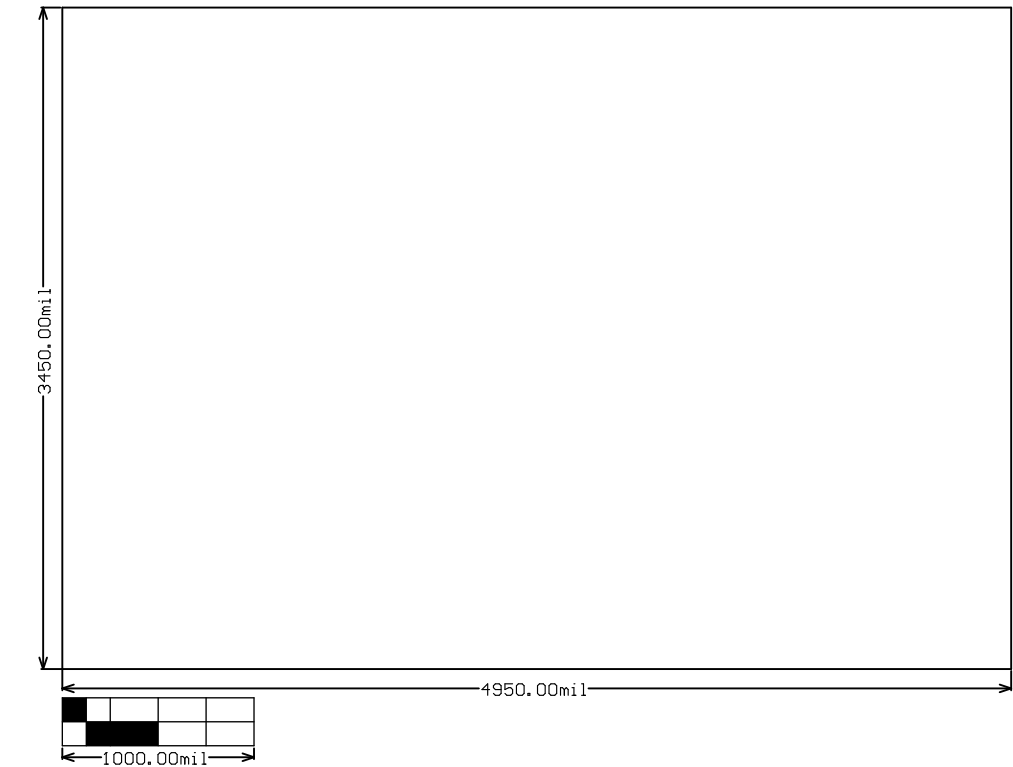
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01419	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA01419		
PLOT NAME = Bottom Layer	GENERATED : 4/13/2017 2:03:09 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01419	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA01419		
PLOT NAME = Bottom Solder Mask	GENERATED : 4/13/2017 2:03:11 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01419	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA01419		
PLOT NAME = Drill Drawing	GENERATED : 4/13/2017 2:03:15 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01419	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA01419		
PLOT NAME = Board Dimensions	GENERATED : 4/13/2017 2:03:17 PM	TEXAS INSTRUMENTS	

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